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SERIAL NUMBER 10/617,827	FILING OR 371(c) DATE 07/14/2003 RULE	CLASS 524	GROUP ART UNIT 1712	ATTORNEY DOCKET NO. 0171-0990P	
APPLICANTS Shoichi Osada, Gunma-ken, JAPAN; Eiichi Asano, Gunma-ken, JAPAN; Shigeki Ino, Gunma-ken, JAPAN; Takayuki Aoki, Gunma-ken, JAPAN; Kazutoshi Tomiyoshi, Gunma-ken, JAPAN; Toshio Shiobara, Gunma-ken, JAPAN; ** CONTINUING DATA ***** This application is a DIV of 09/558,384 04/26/2000 PAT 6,630,745 ** FOREIGN APPLICATIONS ***** JAPAN 11-118155 04/26/1999 JAPAN 11-118408 04/26/1999 IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 10/07/2003					
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after met Allowance Verified and Acknowledged <u> </u> Examiner's Signature <u> </u> Initials <u> </u>		STATE OR COUNTRY JAPAN	SHEETS DRAWING 0	TOTAL CLAIMS 9	INDEPENDENT CLAIMS 1
ADDRESS 002292					
TITLE Semiconductor encapsulating epoxy resin composition and semiconductor device					
FILING FEE RECEIVED 750	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		